

L Number	Hits	Search Text	DB	Time stamp
2	47	"bond wafer" and SOI	USPAT; US-PGPUB	2002/08/23 10:25
3	1	((COP or "crystal originated particles") with (eliminated or eliminating or reduced or reduce or reducing or eliminate) with (wafer or substrate)) and ("bond wafer" and SOI)	USPAT; US-PGPUB	2002/08/23 10:25
1	22	(COP or "crystal originated particles") with (eliminated or eliminating or reduced or reduce or reducing or eliminate) with (wafer or substrate)	USPAT; US-PGPUB	2002/08/23 10:26